



DMP2040UND

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D TA = +25°C	
-20V	$36m\Omega @ V_{GS} = -4.5V$	-5.3A	
-20V	$60 \text{m}\Omega @ \text{V}_{\text{GS}} = -2.5 \text{V}$	-3.9A	

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- **Power Management Functions**
- **DC-DC** Converters

DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

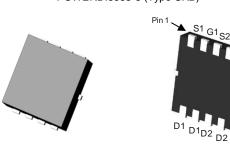
Features

- **Dual P-Channel MOSFET**
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

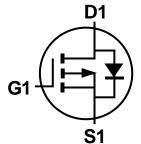
- Case: POWERDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072 grams (Approximate)



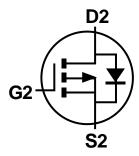
Top View

Bottom View

S1 G1 S2



P-Channel MOSFET



P-Channel MOSFET

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2040UND-7	POWERDI3333-8 (Type UXB)	2000/Tape & Reel
DMP2040UND-13	POWERDI3333-8 (Type UXB)	3000/Tape & Reel

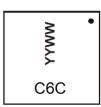
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. Notes:

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



C6C = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 for 2020) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated. DMP2040UND Document number: DS42189 Rev. 3 - 2

1 of 7 Downloaded From Oneyac.com

POWERDI3333-8 (Type UXB)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-20	V		
Gate-Source Voltage	Vgss	±12	V		
Continuous Drain Current (Note 6) V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	-5.3 -4.2	А
Continuous Drain Current (Note 7) $V_{GS} = -4.5V$	Steady State	Tc = +25°C T _C = +70°C	lo	-13.6 -10.9	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ідм	-25	А		
Continuous Source-Drain Diode Current (Note 6)			ls	-1.9	А
Avalanche Current (Note 8) L = 0.1mH			I _{AS}	-19	А
Avalanche Energy (Note 8) L = 0.1mH			Eas	18	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	148	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	88	°C/W
Thermal Resistance, Junction to Case (Note 7)	Steady State	Rejc	13.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)				•	•	·	
Drain-Source Breakdown Voltage	BVDSS	-20	—	—	V	$V_{GS} = 0V, I_{D} = -250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	—	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)						·	
Gate Threshold Voltage	VGS(TH)	-0.6	—	-1.5	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Bravern	_	28	36	mΩ	$V_{GS} = -4.5V, I_D = -8.9A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	38	60	11152	$V_{GS} = -2.5V, I_D = -6.9A$	
Diode Forward Voltage	Vsd	_	-0.7	-1.2	V	VGS = 0V, IS = -2.9A	
DYNAMIC CHARACTERISTICS (Note 10)					•	÷	
Input Capacitance	Ciss		834	_		V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss		133	—	pF		
Reverse Transfer Capacitance	Crss	_	105	_			
Gate Resistance	Rg	_	4.9	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	9.6	—			
Total Gate Charge (V _{GS} = -10V)	Qg	_	20	—	nC	V _{DS} = -6V, I _D = -8.9A	
Gate-Source Charge	Qgs	_	1.1	_	nc		
Gate-Drain Charge	Qgd	_	2.6				
Turn-On Delay Time	t _{D(ON)}	_	14.6	_			
Turn-On Rise Time	tR	_	5.5	_		$V_{DD} = -6V, R_L = 6\Omega$	
Turn-Off Delay Time	tD(OFF)		38.7	_	ns	$V_{GS} = -4.5V, R_g = 6\Omega, I_D = -1A$	
Turn-Off Fall Time	tF		18.3	_	1		
Body Diode Reverse Recovery Time	t _{RR}	_	9.8	_	ns	I _F = -8.9A, di/dt = -100A/µs	
Body Diode Reverse Recovery Charge	Qrr	_	2.7	_	nC	IF = -8.9A, di/dt = -100A/µs	

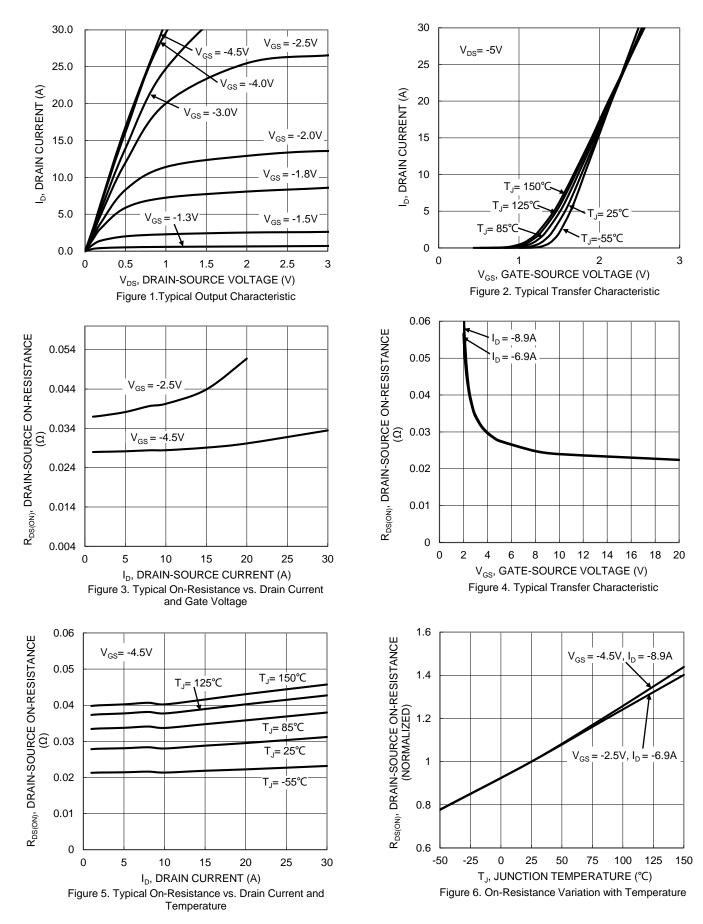
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1 inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

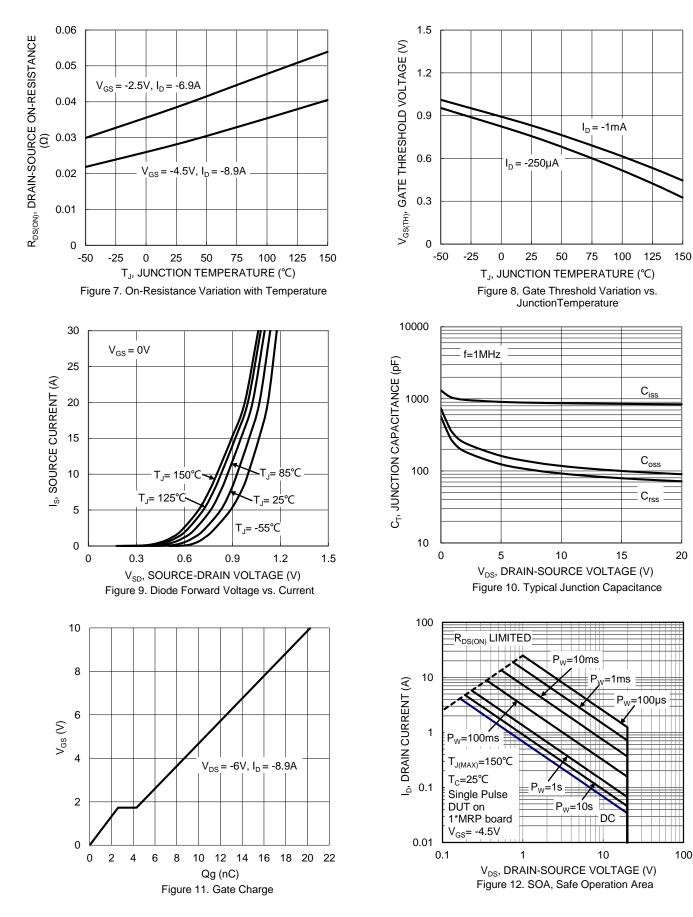




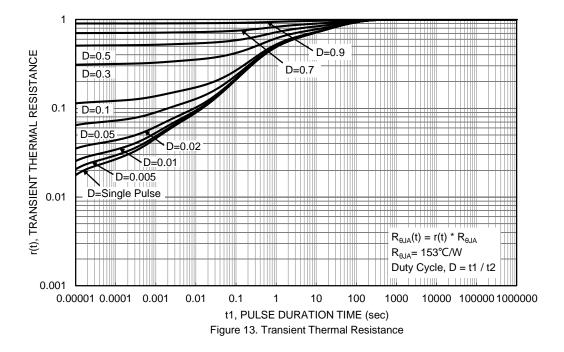
DMP2040UND Document number: DS42189 Rev. 3 - 2



DMP2040UND



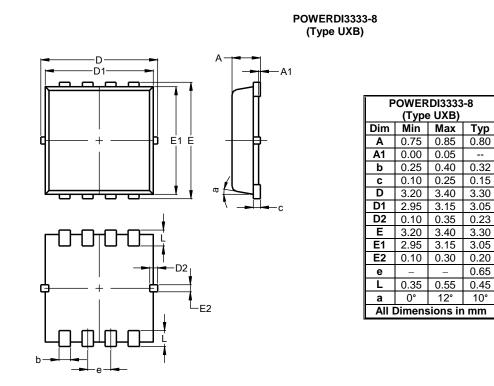






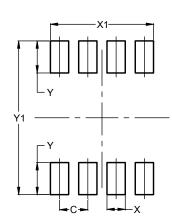
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	2.370
Y	0.730
Y1	3.500

POWERDI3333-8 (Type UXB)



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2020, Diodes Incorporated

www.diodes.com

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))